

2SK2738

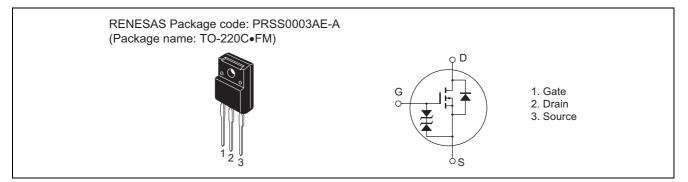
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1032-0200 (Previous: ADE-208-483) Rev.2.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS} = 15 \text{ m}\Omega \text{ typ}$
- High speed switching
- 4 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	40	A
Drain peak current	I _{D(pulse)} * ¹	160	A
Body to drain diode reverse drain current	I _{DR}	40	A
Avalanche current	AP*3	40	A
Avalanche Energy	E _{AR} * ³	137	mJ
Channel dissipation	Pch* ²	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

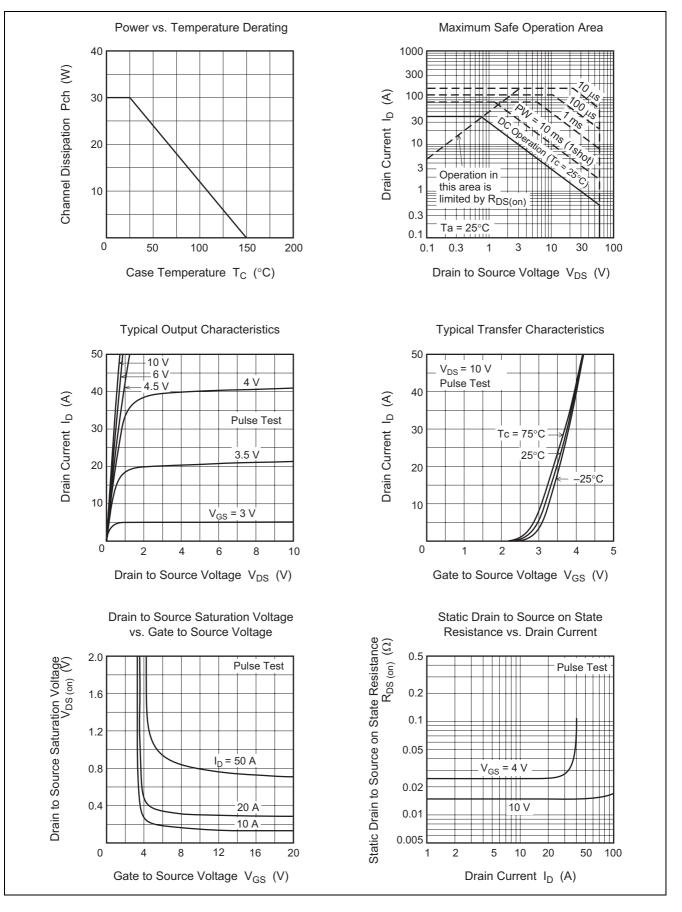
3. Value at Tch = 25°C, Rg \geq 50 Ω

Electrical Characteristics

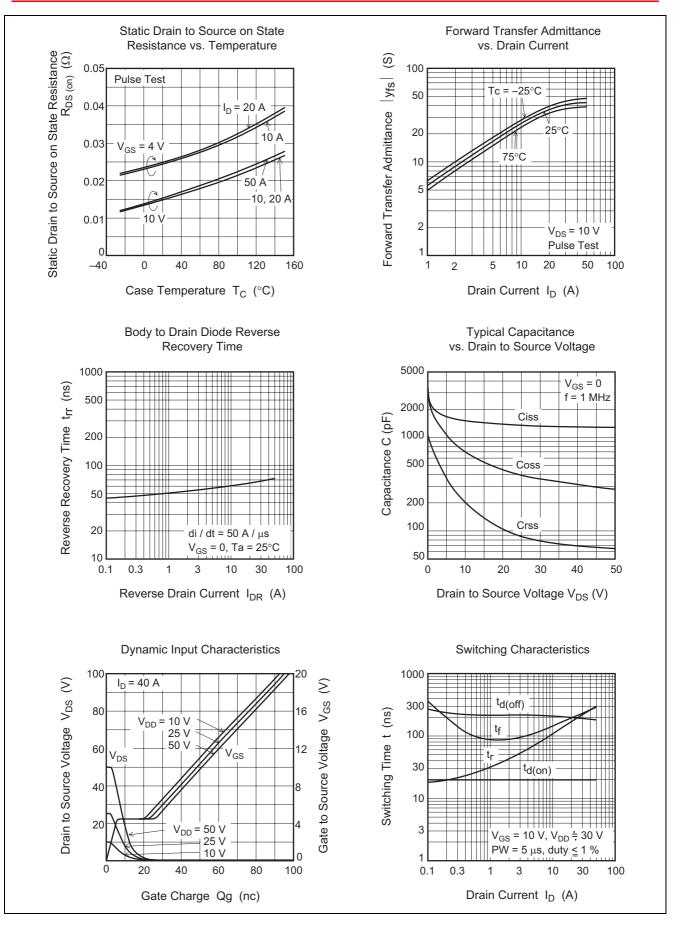
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	10	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.5	_	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	15	20	mΩ	$I_D = 20 \text{ A}, V_{GS} = 10 \text{ V}^{\star 4}$
resistance	R _{DS(on)}		25	40	mΩ	$I_D = 20 \text{ A}, V_{GS} = 4 \text{ V}^{\star 4}$
Forward transfer admittance	y _{fs}	20	35		S	$I_D = 20 \text{ A}, V_{DS} = 10 \text{ V}^{\star 4}$
Input capacitance	Ciss		1500		pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss	_	720	_	pF	
Reverse transfer capacitance	Crss	_	200	_	pF	
Turn-on delay time	t _{d(on)}	_	20	_	ns	$I_D = 20 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$ $R_L = 1.5 \Omega$
Rise time	tr		180		ns	
Turn-off delay time	t _{d(off)}		200		ns	
Fall time	t _f	_	200	_	ns	
Body to drain diode forward voltage	V _{DF}		0.95		V	$I_F = 40 \text{ A}, V_{GS} = 0$
Body to drain diode reverse	t _{rr}		70		V	$I_F = 40 \text{ A}, V_{GS} = 0$
recovery time						di _F / dt = 50A/ μs

Note: 4. Pulse test

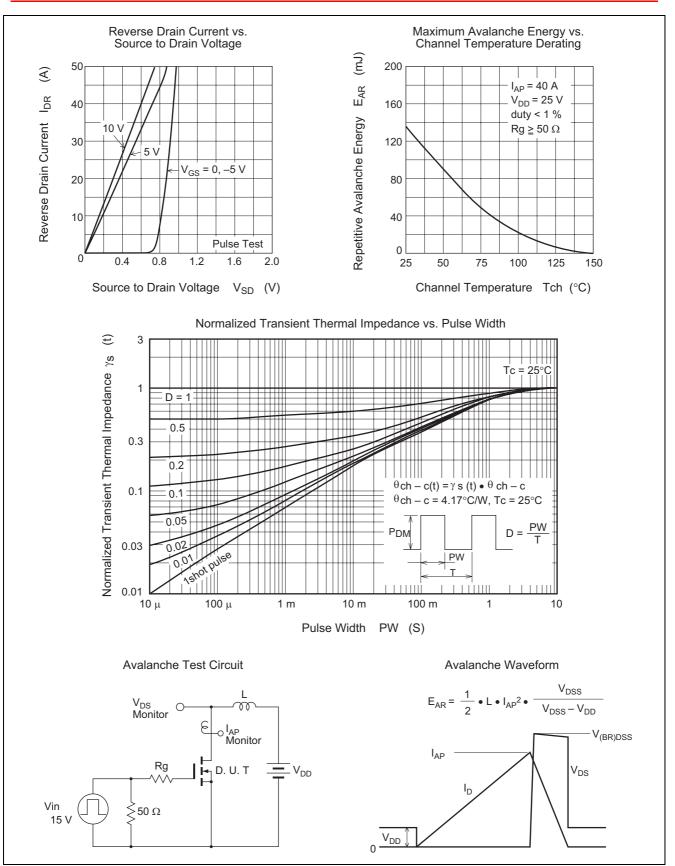
Main Characteristics



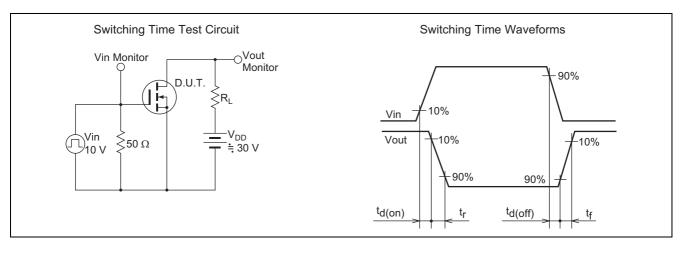






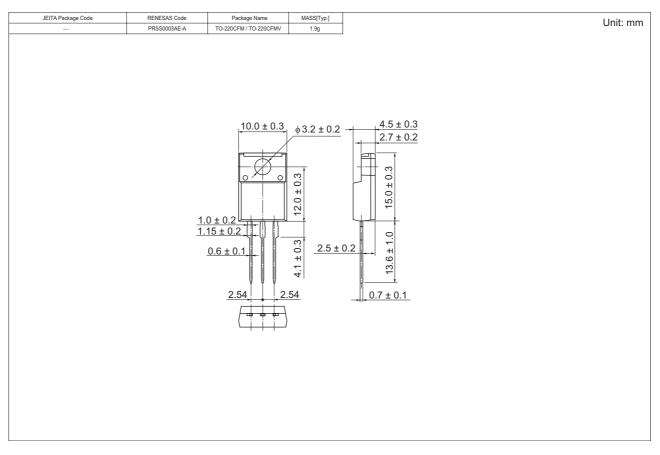








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2738-E	50 pcs	Plastic magazine

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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